

R6500 MICROCOMPUTER SYSTEM DATA SHEET

R6511Q ONE-CHIP MICROPROCESSOR

INTRODUCTION

The Rockwell R6511Q is an extended, high performance 8-bit NMOS-3, microprocessor on a single chip, and is compatible with all members of the R6500 family.

The R6511Q contains an enhanced R6502 CPU, an internal clock oscillator, 192 bytes of Random Access Memory, and versatile interface circuitry. The interface circuitry includes two 16-bit programmable timer/counters, 32 bidirectional input/output lines (including four edge sensitive lines and input latching on one 8-bit port), a full-duplex serial I/O channel, ten interrupts and bus expandability. A full 16-bit address bus and 8-bit data bus provide accessing to 65K bytes of external memory.

The R6511Q comes in a 64-pin Quad Inline package (QUIP)

The R6511Q may be used as a CPU-RAM-I/O counter device in multichip systems or as an emulator for the R6500/11 family of microcomputers. The R6511 provides all R6500/11 interface lines, plus the address bus, data bus and control lines to interface with external memory.

SYSTEMS DEVELOPMENT

Rockwell supports development of the R6511Q with the System 65 Microcomputer Development System and the R6500/13 Personality Set. Complete in-circuit emulation with the Personality Set allows total systems test and evaluation.

This data sheet assumes that the reader is familiar with the R6502 CPU hardware and programming capabilities. A detailed description of the R6502 CPU hardware is included in the R6500 Microcomputer Systems Hardware Manual (Document Number 29650N31). A description of the instruction capabilities of the R6502 CPU is contained in the R6500 Microcomputer System Programming Manual (Document Number 29650N30).

Ordering Information

Number Typ R6511Q Plastic (C	Package Type	Frequency Option	Temp. Range
1,4000000000000000000000000000000000000	Plastic (QUIP)	1 MHz	0 C to 70 C
R6511AQ	Plastic (QUIP)	2 MHz	0 C to 70 C

FEATURES

- Enhanced 6502 CPU
 - Four new bit manipulation instructions
 Set Memory Bit (SMB)
 Reset Memory Bit (RMB)
 Branch on Bit Set (BBS)
 Branch on Bit Reset (BBR)
 - · Decimal and binary arithmetic modes
 - 13 Addressing modes
 - True indexing
- . 192-byte static RAM /
- 32 bidirectional, TTL-compatible I/O lines (four ports)
- One 8-bit port may be tri-stated under software control
- One 8-bit port may have latched inputs under software control
- Two 16-bit programmable counter/timers, with latches
 - Pulse measurement
 - Pulse generation
 - Interval timer
 - Event counter
 - Retriggerable interval timer
- Serial Port—USART
 - Full-duplex asynchronous operation mode
 - Synchronous shift register mode
 - Selectable 5- to 8-bit characters
 - Wake-up feature
 - Standard programmable bit rates of 9600 bits/sec, programmable up to 62.5K bits/sec (@ 1 MHz clock)
- Ten interrupts
 - · Four edge-sensitive lines; two positive, two negative
 - Two counter overflows
 - Serial data received
 - Serial data transmitted
 - Non-maskable
 - Reset
- Full data & address pins for 65K bytes of external memory
- Flexible clock circuitry
 - 2-MHz or 1-MHz internal operation
 - Internal clock with external XTAL at two times internal frequency
 - External clock input divided by one or two.
- 1 μs minimum instruction execution time at 2 MHz
- NMOS-3 silicon gate, depletion load technology
- Single 5V power supply
- 12 mW stand-by power for 32 bytes of the 192-byte RAM
- · 64-pin QUIP

CENTRAL PROCESSING UNIT (CPU)

The R6511Q internal CPU is a standard R6500 configuration with the standard R6500 instructions plus 4 new bit manipulation instructions. These new bit manipulator instructions form an enhanced R6500 instruction set and simplify programming.

Set Memory Bit (SMB #,ADDR.)

This instruction sets to "1" one bit of the 8-bit data field specified by the zero page address (memory or I/O port). The first byte of the instruction specifies the SMB operation and which one of 8 bits to be set. The second byte of the instruction designates the address (0-255) of the byte to be operated upon.

Reset Memory Bit (RMB #,ADDR.)

This instruction is the same operation and format as the SMB instruction except a reset to "0" of the bit results.

Branch on Bit Set Relative (BBS #,ADDR.,DEST)

This instruction tests one of 8 bits designated by a 3-bit immediate field within the first byte of the instruction. The second byte is used to designate the location of the byte to be tested within the zero page address range (memory or I/O ports). The third byte of the instruction is used to specify the 8-bit relative address to which the instruction branches if the bit tested is a "1". If the bit tested is not set, the next sequential instruction is executed.

Branch on Bit Reset Relative (BBR #,ADDR.,DEST)

This instruction is the same operation and format as the BBS instruction_except that a branch takes place if the bit tested is a "0".

Random Access Memory (RAM)

The RAM consists of 192 by 8 bits of read/write memory with an assigned page zero address of 0040 through 00FF. The R6511Q provides a separate power pin (V_{RR}) which may be used for standby power. In the event of the loss of V_{CC} power, the lowest 32 bytes of RAM data will be retained if standby power is supplied to the V_{RR} pin.

Clock Oscillator

The clock oscillator provides the basic timing signals. A reference frequency can be generated with the on board oscillator (with external crystal) or an external reference source can be driven into the XTLI pin. If the XTLO pin is left floating, the reference frequency is internally divided by two to obtain the internal clock. The internal clock is then available as an output at the 2 pin. The XTLI pin may be used as an undivided clock input by connecting XTLO to V_{ss}, in which case the internal division circuitry is bypassed and the device operates at the reference frequency.

Parallel Input/Output Ports

The R6511Q has 32 I/O lines grouped into four 8-bit ports (PA, PB, PC, PD). Ports A through C may be used either for

input or output individually, or in groups of any combination.

Port D may be used as all inputs or all outputs.

Port A (PA)

Port A can be programmed as a standard parallel 8-bit I/O port or under software control as serial I/O lines, counter I/O lines, positive (2) and negative (2) edge detects, or an input data strobe for the Port B (PB) input latch option.

Port B (PB)

Port B can be programmed as an I/O port with latched input enabled or disabled.

Port C (PC)

Port C can be programmed as an I/O port, as an abbreviated bus, as a multiplexed bus, or as part of the full address mode. In the full address mode pins PC6 and PC7 serve as addresses A13 and A14 respectively.

Port D (PD)

Port D functions as an I/O port, an 8-bit tri-state data bus, or as a multiplexed address/data bus.

Serial Input/Output Channel-USART

The R6511Q microprocessor provides a full duplex serial I/O channel with programmable bit rates and operating modes. The serial I/O channel is register controlled for setting standard bit modes to 61.5K bits per second (@ 1 MHz clock) automatically utilizing Counter A.

Wake-Up Feature

In a multi-distributed microprocessor or microcomputer applications, a destination address is usually included at the beginning of the message. The Wake-Up Feature allows non-selected CPUs to ignore the remainder of the message until the beginning of the next message by setting the Wake-Up bit.

Counter/Latch Logic

The R6511Q microprocessor contains two 16-bit counters (Counter A and Counter B) and three 16-bit latches associated with the counters. Counter A has one 16-bit latch and Counter B has two 16-bit latches. Each counter can be independently programmed to operate in one of four modes:

Counter A

- Pulse width measurement
- Pulse Generation
- Interval Timer
- Event Counter

Counter B

- Retriggerable Interval Counter
- Asymetrical Pulse Generation
- Interval Timer
- Event Counter

Mode Control Register (MCR)

The Mode Control Register contains control bits for the multifunction I/O ports and mode select bits for Counter A and Counter B.

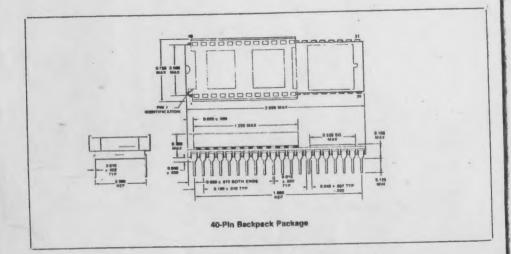
Ports C & D Operation Modes

There are four operating modes available in ports C & D, software programmable via the Mode Control Register. The

R6500 Microcomputer System

ELECTRICAL CHARACTERISTICS

= 5.0 ± 5%, V _{SS} = 0, T _A = 25°C) Cheracteristic	Symbol	Min	Тур	Max	Unit
Input High Threshold Voltage 00-07	VINT	V ₈₈ + 2.0	-	_	Vdlo
Input Low Threshold Voltage D0-D7	VILT	-	-	V _{SS} + 0.8	Vdc
Three-State (Off State) Input Current (V = 0.4 to 2.4V, V _{CC} = 5.25V) D0-D7	ITBI	_	-	± 10	μΑ
Output High Voltage (ILOAD = 100 A Adc, V _{CC} = 4.75V) DD-D7, A0-A11, OE, CE	V _{ОМ}	V ₃₈ + 2.4	-		Vdc
Output Low VoRage (ILDAD = 1.6 mAde, V _{CC} = 4.75V) DO-D7, AO-A11, OE, CE	Vol	_	_	V ₉₈ + 0.4	Vdc
Power Dissipation (less EPROM)	Po	-	0.80	1.20	W
Capacitance (V _{In} = 0, T _A = 25°C, f = 1 MHz) D0-D7 (High Impedence State) Input Capacitance	C Cost Cin	=,	=	10	pF
VO Port Pull-up Resistance	RL	3.0	6.0	11.5	kohm





R6500/13 and R6511Q ONE-CHIP MICROCOMPUTER and ONE-CHIP MICROPROCESSOR

SECTION 1 INTRODUCTION

1.1 FEATURES

- e Enhanced 6502 CPU
- -Four new bit manipulation instructions
 - . Set Memory Bit (SMB)
 - a Reset Memory Bit (RMB)
 - . Branch on Bit Set (BBS)
 - . Branch on Bit Reset (BBR)
- -Decimal and binary arithmetic modes
- -13 addressing modes
- -True indexing
- 256-byte mask-programmable ROM or no ROM*
- . 192-byte static RAM
- 32 bidirectional, TTL-compatible VO lines (four ports) One 8-bit port may be tri-stated under software control
- . One 8-bit port may have tatched inputs under software
- Two 16-bit programmable counter/timers, with latches
- -Pulse width measurement
- --- Asymmetrical pulse generation
- -Pulse generation
- -Interval timer
- -Event counter
- -Retriggerable Interval timer
- -Full-duplex asynchronous operation mode
- -Selectable 5- to 8-bit characters
- -Wake-up feature
- -Synchronous shift register mode
- -Standard programmable bit rates programmable up to 62.5K bits/sec @ 1 MHz
- Ten interrupts
- -Four edge-sensitive lines; two positive, two negative
- -Reset
- -Non-maskable
- -Two counter underflows
- -Serial data received
- -Serial data transmitted
- Bus expandable to 64K bytes of external memory *R6511Q has no ROM.

- · Flexible clock circuitry
- -2-MHz or 1-MHz internal operation
- -Internal clock with external XTAL at two or four times Internal frequency
- -External clock input divided by one, two or four
- 1μs minimum instruction execution time @ 2 MHz
- NMOS-3 silicon gate, depletion load technology
- · Single +5V power supply
- 12 mW stand-by power for 32 bytes of the 192-byte RAM
- · 64-pin QUIP

NOTE

This document uses the term R6500/13 to describe both parts. See section 1.3 for a description of the options available when using the R6500/13 and the fixed features of the R6511Q.

1.2 SUMMARY

The Rockwell R6500/13 is a complete, high-performance 8-bit NMOS-3 microcomputer on a single chip and is compatible with all members of the R6500 family.

The R6500/13 consists of an enhanced 6502 CPU, an internal clock oscillator, an optional 256 bytes of Read-Only Memory, 192 bytes of Random Access Memory (RAM) and versatile interface circuitry. The interface circuitry includes two 16-bit programmable timer/counters, 32 bidirectional input/output lines (including four edge-sensitive lines and input latching on one 8-bit port), a full-duplex serial I/O channel, ten interrupts and bus expandability.

The innovative architecture and the demonstrated high performance of the R6502 CPU, as well as instruction simplicity, results in system cost-effectiveness and a wide range of computational power. These features make the R6500/13 a leading candidate for microcomputer applications.

The R6511Q contains all the features of the R6500/13 except it has no ROM and is thus intended as a high feature microprocessor with full 65K address bus.

To allow prototype circuit development, Rockwell offers a PROM-compatible 64-pin extended microprocessor device. This device, the R6511Q, provides all R6500/11 interface lines, pius the address bus, date bus and control lines to interface with external memory. The R6511Q also can be used to emulate the R6500/13. With the addition of external circuits it can also emulate the R6500/12.

Rockwell supports development of the R6500/13 with the System 65 Microcomputer Development System and the R6500/* Family of Personality Modules. Complete in-circuit emulation with the R6500/* Family of Personality Modules allows total system test and evaluation.

This product description assumes that the reader is familiar with the R8502 CPU hardware and programming capabilities. A detailed description of the R6502 CPU hardware is included in the R6500 Microcomputer System Herdware Manual (Document Number 29650N31). A description of the instruction capabilities of the R6502 CPU is contained in the R6500 Microcomputer System Programming Manual (Document Number 29650N30).

1.3 CUSTOMER OPTIONS

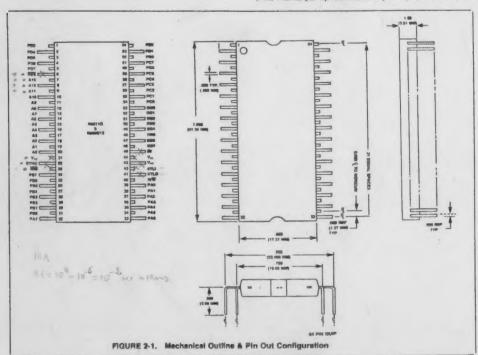
The R8500/13 microcomputer is available with the following customer specified mask options.

- . Option 1 Crystal or RC oscillator
- . Option 2 Clock divide by 2 or 4
- . Option 3 Clock MASTER Mode or SLAVE Mode
- . Option 4 with or without a 256 byte ROM
- . Option 5 Reset Vector at FFFC or 7FFF
- . Option 6 Port A with or without internal pull-up resistors
- Option 7 Port ⊞ with or without internal pull-up resistors
- . Option 8 Port C with or without internal pull-up resistors

All options should be specified on an R6500/13 order form.

The R8511Q has no customer specified mask options. It has the following characteristics.

- Crystal Oscillator
- . Clock Divide by 2
- Clock MASTER Mode
- Without ROM
- Reset Vector at FFFC
- . No internal pull-up resistors or any Port (PA, PB, or PC)



R6511Q Microprocessor and R6500/13 Microcomputer

SECTION 2 R6511Q AND R6500/13 INTERFACE REQUIREMENTS

This section describes the Interface requirements for the R6511Q and R6500/13. Figure 2-1 and 2-2 show the interface Diagram and the pin out configuration for both devices. Table 2-1 describes the function of each pin. Figure 3-1 has a detailed block diagram of the R6500/13 ports which illustrates the internal function of the device.

TABLE 2-1. R6500/13 Pin Descriptions

SIGNAL NAME | PIN NO.

DESCRIPTION

high when reading and low

OTOTION INVINE		
Vec	21	Main power supply +5V
Von	43	Separate power pin for RAM.
		In the event that V _{cc} power
		is off, this power retains RAM
		data.
V _{ee}	44	Signal and power ground (0V)
XTLI	42	Crystal or clock input for in-
		ternal clock oscillator. Also
		allows input of X1 clock sig-
		nal if XTLO is connected to
	0-	V _{ss} , or X2 or X4 clock if XTLO Is floated.
	41-	Crystal output from internal
XTLO	41	clock oscillator.
		The Reset input is used to
RES	6	initialize the device. This sig-
		nel must not transition from
		low to high for at least eight
		cycles after V _{cc} reaches op-
		erating range and the inter-
		nal oscillator has stabilized.
1/2	45	Clock signal output at inter-
p.c.		nal frequency.
NMI	23	A negative going edge on the
, white		Non-Maskable Interrupt sig-
		nal requests that a non-
		maskable interrupt be gen-
		erated with the CPU.
PAO-PA7	39-32	Four 8-bit ports used for
PB0-PB7	31-24	either input/output. Each line
PC0-PC7	54-61	of Ports A, B and C consists
PD0-PD7	82-84,	of an active transistor to V _{se}
	1-5	and an optional passive pull-
		up to V _{cc} . In the abbreviated or multiplexed modes of op-
		eration Port C has an active
		pull-up transistor. Port D
		functions as either an 6-bit
		Input or 8-bit output part. It
		has active pull-up and pull-
	1	down transistors.
A0-A12, A15	20-7	Fourteen address lines used
		to address a complete
		65K external address space.
		Note: A13 & A14 are sourced
		through PC8 & PC7 when in
		the Full Address Mode.
DB0-DB7	53-48	Eight bidirectional data bus
		lines used to transmit data to
		and from external memory.
SYNC	22	SYNC is a positive going sig-
		net for the full clock cycle
		whenever the CPU is per- forming an OP CODE letch.
- 277	1	Controls the direction of data
R/W	40	transfer between the CPU
	1	and the external 65K ad-
1		dress space. The signal is
		arrange absence:a mile day on

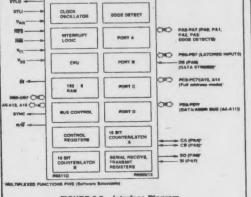


FIGURE 2-2. Interface Diagram

SECTION 3 SYSTEM ARCHITECTURE

This section provides a functional description of the R6500/ 13. Functionally the R6500/13 consists of a CPU, both RAM and optional ROM memories, four 8-bit parallel I/O ports, a serial I/O port, dual counter/latch circuits, a mode comfol reglater, and an interrupt flag/enable dual register circuit. A block diagram of the system is shown in Figure 3-1.

NOTE

Throughout this document, unless specified otherwise, all memory or register address locations are specified in hexadecimal notation.

3.1 CPU LOGIC

The R6500/13 internal CPU is a standard 6502 configuration with an 8-bit Accumulator register, two 8-bit Index Registers (X and Y); an 8-bit Stack Pointer register, an ALU, a 16-bit Program Counter, and standard instruction register/decode and internal timing control logic.

3.1.1 Accumulator

The accumulator is a general purpose 8-bit register that stores the results of most arithmetic and logic operations, in addition, the accumulator usually contains one of the two data words used in these operations.

3.1.2 Index Registers

There are two 6-bit index registers, X and Y. Each index register can be used as a base to modify the address data program counter and thus obtain a new address—the sum of the program counter contents and the index register contents.

When executing an instruction which specifies indirect addressing, the CPU fetches the op code and the address and modifies the address from memory by adding the index register to it prior to loading or storing the value of memory.

Indexing greatly simplifies many types of programs, especially those using data tables.

3.1.3 Stack Pointer

The Stack Pointer is an 8-bit register. It is automatically incremented and decremented under control of the micro-processor to perform stack manipulation in response to either user instructions, an internal IRQ interrupt, or the external interrupt line NMI. The Stack Pointer must be initialized by the user program.

The stack allows simple implementation of multiple level interrupts, subroutine nesting and simplification of many types of data manipulation. The JSR, BRK, RTI and RTS instructions use the stack and Stack Pointer.

The stack can be envisioned as a deck of cards which may be accessed only from the top. The address of a memory

location is stored (or "pushed") onto the stack. Each time data are to be pushed noto the stack, the Stack Pointer is placed on the Address Bus, data are written into the memory location addressed by the Stack Pointer, and the Stack Pointer is decremented by 1. Each time data are read (or "pulled") from the stack, the Stack Pointer is incremented by 1. The Stack Pointer is then placed on the Address Bus and data are read from the memory location addressed by the Pointer.

The stack is located on zero page, i.e., memory locations 00FF-0040. After reset, which leaves the Stack Pointer Indeterminate, normal usage calls for its initialization at 00FF.

3.1.4 Arithmetic And Logic Unit (ALU)

All arithmetic and logic operations take place in the ALU, including incrementing and decrementing internal registers (except the Program Counter). The ALU cannot store data for more than one cycle. If data are placed on the inputs to the ALU at the beginning of a cycle, the result is always gated into one of the storage registers or to external memory during the next cycle.

Each bit of the ALU has two inputs. These inputs can be tied to various internal buses or to a logic zero; the ALU then generates the function (AND, OR, SUM, and so on) using the data on the two inputs.

3.1.5 Program Counter

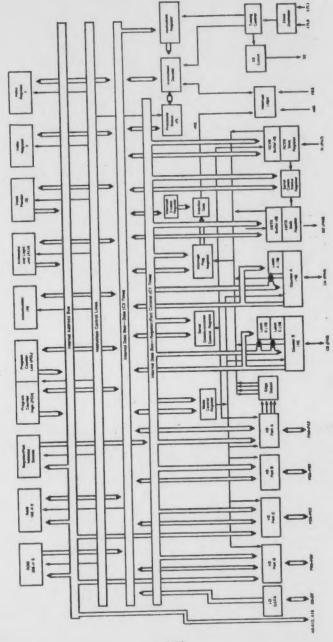
The 16-bit Program Counter provides the addresses that are used to step the processor through sequential instructions in a program. Each time the processor fetches an instruction from program memory, the lower (least significant) byte of the Program Counter (PCL) is placed on the low-order bits of the Address Bus and the higher (most significant) byte of the Program Counter (PCH) is placed on the high-order 8 bits of the Address Bus. The Counter is incremented each time an instruction or data is fetched from program memory.

3.1.6 Instruction Register and Instruction Decode

Instructions are fetched from ROM or RAM and gated onto the Internal Data Bus. These instructions are latched into the Instruction Register, then decoded along with timing and interrupt signals to generate control signals for the various registers.

3.1.7 Timing Control

The Timing Control Logic keeps track of the specific instruction cycle being executed. This logic is set to TO each time an instruction fetch is executed and is advanced at the beginning of each Phase One clock pulse for as many cycles as are required to complete the instruction. Each data transfer which takes place between the registers is caused by decoding the contents of both the instruction register and timing control unit.



3.1.8 Interrupt Logic

Interrupt logic controls the sequencing of three interrupts; RES, NMI and IRO, IRO is generated by any one of eight conditions: 2 Counter Overflows, 2 Positive Edge Detects, 2 Negative Edge Detects, and 2 Serial Port Conditions.

3.2 NEW INSTRUCTIONS

In addition to the standard R6502 instruction set, four new bit manipulation instructions have been added to the R6500/13. The added instructions and their format are explained in the following paragraphs. Refer to Appendix A for the Op Code mnemonic addressing matrix for these added instructions. The four added instructions do not impact the CPU processor status register.

3.2.1 Set Memory Bit (SMB m, Addr.)

This instruction sets to "1" one of the 8-bit data field specified by the zero page address (memory or I/O port). The first byte of the instruction specifies the SMB operation and one of eight bits to be set. The second byte of the instruction designates address (0-255) of the byte to be operated upon.

3.2.2 Reset Memory Bit (RMB m, Addr.)

This instruction is the same operation and format as SMB instruction except a reset to "0" of the bit results.

3.2.3 Branch On Bit Set Relative (BBS m, Addr, DEST)

This instruction tests one of eight bits designated by a 3-bit immediate field within the first byte of the instruction. The second byte is used to designate the address of the byte to be tested within the zero page address range (memory or I/O ports). The third byte of the instruction is used to specify the 8-bit relative address to which the instruction branches if the bit tested is a "f". If the bit tested is not set, the next sequential instruction is executed.

3.2.4 Branch On Bit Reset Relative (BBR m, Addr, DEST)

This instruction is the same operation and formal as the BBS instruction except that a branch takes place if the bit tested is a "0".

3.3 READ-ONLY-MEMORY (ROM)

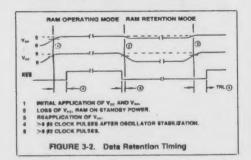
The optional ROM consists of 256 bytes mask programmable memory with an address space from 7500 to 7FFF. ROM locations FFFA to FFFF are assigned for interrupt vectors. The reset vector can be optionally at 7FFE or FFFC.

The R6511Q has no ROM and its Reset vector is at FFFC.

3.4 RANDOM ACCESS MEMORY (RAM)

The RAM consists of 192 bytes of read/write memory with an assigned page zero address of 0040 through 00FF. The R6500/13 provides a separate power pin ($V_{\rm na}$) which may be used for standby power for 32 bytes located at 0040-005F. In the event of the loss of $V_{\rm oc}$ power, the lowest 32 bytes of RAM data will be retained if standby power is supplied to the $V_{\rm na}$ pin. If the RAM data retention is not required then $V_{\rm na}$ must be connected to $V_{\rm cc}$. During operation $V_{\rm na}$ must be at the $V_{\rm cc}$ level.

For the RAM to retain data upon loss of $V_{\rm CC}$, $V_{\rm NR}$ must be supplied within operating range and RES must be driven low at least eight $\emptyset 2$ clock pulses before $V_{\rm CC}$ falls out of operating range. RES must then be held low while $V_{\rm CC}$ is out of operating range and until at least eight $\emptyset 2$ clock cycles after $V_{\rm CC}$ is again within operating range and the internal $\emptyset 2$ oscillator is stabilized. $V_{\rm NR}$ must remain within $V_{\rm CC}$ operating range during normal operation. When $V_{\rm CC}$ is out of operating range, $V_{\rm NR}$ must remain within the $V_{\rm NR}$ retention range in order to retain date. Figure 3.2 shows typical waveforms.



R6511Q Microprocessor and R6500/13 Microcomputer

3.5 CLOCK OSCILLATOR

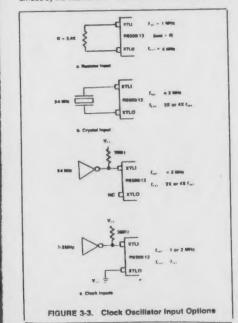
The R6511Q has been configured for a crystal oscillator, a divide by 2 countdown network, and for Master Mode Operation.

Three customer selectable mask options are available for controlling the R6500/13 timing. The R6500/13 can be ordered with a crystal or AC oscillator, a divide by 2 or divide by 4 countdown network and for clock master mode or clock slave mode operation.

For 2MHz interval operation the divide-by-2 options must be specified.

A reference frequency can be generated with the on-chip oscillator using either an external crystal or an external resistor depending on the mask option selected. The oscillator reference frequency passes through an internal countdown network (divide by 2 or divide by 4 option) to obtain the internal operating frequency (see Figures 3-3a and 3-3b). The external crystal generated reference frequency is a preferred method since the resistor method can have tolerances approaching 50%.

Internal timing can also be controlled by driving the XTL1 pln with an external frequency source. Figure 3-3c shows typical connections. If XTLO is left floating, the external source is divided by the internal countdown network, However, if XTLO



is tied to V_{sq}, the internal countdown network is bypassed causing the chip to operate at the frequency of the external source.

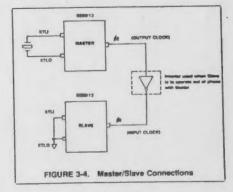
The operation excribed above assumed a CLOCK MASTER MODE mask option. In this mode a frequence source (crystal, RC network, or external source) must be applied to the XTLI and XTLO pins.

Medi

When operating at a 1 MHz internal frequency place a 15-22 pt capacitor between XTLO and GND.

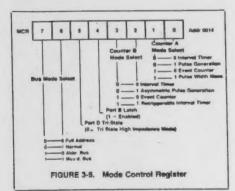
Ø2 is a buffered output signal which closely approximates the internal timing. When a common external source is used to drive multiple devices the internal timing between devices as well as their Ø2 outputs will be skewed in time. If skewing represents a system problem it can be avoided by the Master/Slave connection and options shown in Figure 3-4.

One R8500/13 is operated in the CLOCK MASTER MODE and a second in the CLOCK SLAVE MODE. Mask options in the SLAVE unit convert to \$\frac{1}{2}\$ signal into a clock input pin which is tightly coupled to the internal timing generator. As a result the internal timing of the MASTER and SLAVE units are synchronized with minimum sikew. If the \$\frac{1}{2}\$ signal to the SLAVE unit is inverted, the MASTER and SLAVE UNITS WILL OPERATE OUT OF PHASE. This approach allows the two devices to share external memory using cycle stealing techniques.



3.6 MODE CONTROL REGISTER (MCR)

The Mode Control Register contains control bits for the multifunction I/O ports and mode select bits for Counter A and Counter B. Its setting, along with the setting of the Serial Communications Control Register (SCCPI), determines the basic configuration of the R6500/13 in any application, initializing this register is one of the first actions of any software program. The Mode Control Register bit assignment is shown in Figure 3-5.



The use of Counter A Mode Select is shown in Section 6.1.

The use of Counter B Mode Select is shown in Section 6.2.

The use of Port 8 Latch Enable is shown in Section 4.4.

The use of Port D in Tri-State Enable is shown in Section 4.6.

The use of Bus Mode Select is shown in Section 4.5 and 4.6.

3.7 INTERRUPT FLAG REGISTER (IFR) AND INTERRUPT ENABLE REGISTER (IER)

An IRQ interrupt request can be initiated by any or all of eight possible sources. These sources are all capable of being enabled or disabled by the use of the appropriate interrupt enabled bits in the Interrupt Enable Register (IER). Multiple simultaneous interrupts cause the IRQ interrupt request to remain active until all interrupting conditions have been serviced and cleared.

The Interrupt Flag Register contains the information that indicates which I/O or counter needs attention. The contents of the Interrupt Flag Register may be examined at any time by reading at address: 0011. Edge detect IFR bits may be cleared by executing a RMB instruction at address location 0010. The RMB X, (0010) instruction reads FF, modifies bit X to a "0", and writes the modified value at address location 0011. In this way IFR bits set to a "1" after the read cycle of a Reed-Modify-Write Instruction (such as RMB) are protected from being cleared. A logic "1" is ignored when writing to edge detect IFR bits.

Each IFR bit has a corresponding bit in the Interrupt Enable Register which can be set to a "1" by writing a "1" in the respective bit position at location 0012. Individual IER bits may be cleared by writing a "0" in the respective bit position, or by RES. If set to a "1", an IRQ will be generated when the corresponding IFR bit becomes true. The Interrupt Flag Register and Interrupt Enable Register bit assignments are shown in Figure 3-6 and the functions of each bit are explained in Table 3-1.

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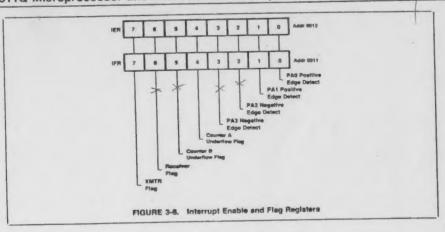


TABLE 3-1. Interrupt Flag Register Bit Codes

BIT	FUNCTION
FR 0:	PA0 Positive Edge Detect Flag—Set to a "1" when a positive going edge is detected on PA0. Cleared by RMB 0 (0010) instruction or by RES.
FR 1:	PA1 Positive Edge Detect Flag—Set to a 1 when a positive going edge is detected on PA1. Cleared by RMB 1 (0010) instruction or by RES.
IFA 2:	PA2 Negative Edge Detect Flag—Set to a 1 when a negative going edge is detected on PA2. Cleared by RMB 2 (0010) instruction or by RES.
IFR 3: "	PA3 Negative Edge Detect Flag.—Set to 1 when a negative going edge is detected on PA3. Cleared by RMB 3 (0010) instruction or by RES.
IFR 4:	Counter A Underflow Flag—Set to a 1 when Counter A underflow occurs. Cleared by reading the Lower Counter A at location 0018, by writing to address location 001A, or by RES.
IFR 5:	Counter B Underflow Flag—Set to a 1 when Counter B underflow occurs. Cleared by reeding the Lower Counter B at location 001C, by writing to address location 001E, or by RES.
IFA 6:	Receiver Interrupt Flag.—Set to a 1 when any of the Serial Communication Status Register bits 0 through 3 is set to a 1. Cleared when the Receiver Status bits (SCSR 0-3) are cleared or by RFS.
IFR 7:	Transmitter Interrupt Flag—Set to a 1 when SCSR 6 is set to a 1 white SCSR 5 is a 0 or SCSR 7 is set to a 1. Cleared when the Transmitter Status bits (SCSR 6.5.7) are cleared or by RES.

3.8.7 Negative Bit (N)

The Negative Bit (N) is used to indicate that the sign bit (bit 7) in the resulting value of a data movement or data arithmetic operation is set to logic 1. If the sign bit is set to logic 1, the resulting value of the data movement or arithmetic operation is negative; if the sign bit is cleared, the result of the data movement or arithmetic operation is positive. There are no instructions that set or clear the Negative Bit since the Negative Bit represents only the status of a result. The instructions that effect the state of the Negative Bit are: ADC, AND, ASL, BIT, CMP, CPX, CPY, DEC, DEX, DEY, EOR, INC, INX, INY, LDA, LDX, LDY, LSR, ORA, PLA, PLP, ROL, ROR, RTI, SBC, TAX, TAY, TSX, TXA, and TYA.

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3.8 PROCESSOR STATUS REGISTER

The 8-bit Processor Status Register, shown in Figure 3-7, contains seven status flags. Some of these flags are controlled by the user program: others may be controlled both by the user's program and the CPU. The R6502 instruction set contains a number of conditional branch instructions which are designed to allow testing of these flags. Each of the eight processor status flags is described in the following sections.

3.8.1 Carry Bit (C)

The Carry Bit (C) can be considered as the ninth bit of an arithmetic operation, it is set to logic 1 if a carry from the eighth bit has occurred or cleared to logic 0 if no carry occurred as the result of arithmetic operations.

The Carry Bit may be set or cleared under program control by use of the Set Carry (SEC) or Clear Carry (CLC) instruction, respectively. Other operations which affect the Carry Bit are ADC, ASL, CMP, CPX, CPY, LSR, PLP, ROL, ROR, RTI, and SBC.

3.8.2 Zero Bit (Z)

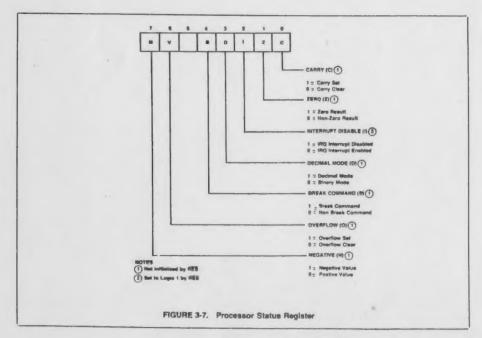
The Zero Bit (Z) is set to logic 1 by the CPU during any data movement or calculation which sets all 8 bits of the result to

zero. This bit is cleared to logic 0 when the resultant 8 bits of a data movement or calculation operation are not all zero. The R6500 instruction set contains no instruction to specifically set or clear the Zero Bit. The Zero Bit is, however, affected by the following instructions; ADC, AND, ASL, BIT, CMP, CPX, CPY, DEC, DEX, DEY, EOR, INC, INX, INY, LDA, LDX, LDY, LSR, ORA, PLA, PLP, ROL, ROR, RTI, SBC, TAX, TAY, TXA, TSX, and TYA.

3.8.3 Interrupt Disable Bit (i)

The Interrupt Disable Bit (I) is used to control the servicing of an interrupt request (IRO). If the I Bit is reset to logic 0, the IRQ signal will be serviced. If the bit is set to logic 1, the IRQ signal will be ignored. The CPU will set the Interrupt Disable Bit to logic 1 if a RESET (RES), IRQ, or Non-Maskable Interrupt (NMI) signal is detected.

The I bit is cleared by the Clear Interrupt Mask Instruction (CLI) and is set by the Set Interrupt Mask Instruction (SEI). This bit is set by the BRK Instruction. The Return from Interrupt (RTI) and Pull Processor Status (PLP) instructions will also affect the I bit.



3.8.4 Decimal Mode Bit (D)

The Decimal Mode Bit (D) is used to control the arithmetic mode of the CPU. When this bit is set to logic 1, the adder operates as a decimal adder. When this bit is cleared to logic 0, the adder operates as a straight binary adder. The adder mode is controlled only by the programmer. The Set Decimal Mode (SED) instruction will set the D bit; the Clear Decimal Mode (CLD) instruction clears it. The PLP and RTI instructions also affect the Decimal Mode Bit.

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CAUTION

The Decimal Mode Bit will either set or clear in an unpredictable manner upon power application. This bit must be initialized to the desired state by the user program or erroneous results may occur.

3.8.5 Break Bit (B)

The Break Bit (B) is used to determine the condition which caused the $\overline{\text{IRO}}$ service routine to be entered. If the $\overline{\text{IRO}}$ service routine was entered because the CPU executed a BRK command, the Break Bit will be set to logic 1. If the $\overline{\text{IRO}}$ routine was entered as the result of an $\overline{\text{IRO}}$ signal being generated, the B bit will be cleared to logic 0. There are no instructions which can set or clear this bit.

3.8.6 Overflow Bit (V)

The Overflow Bit (V) is used to indicate that the result of a signed, binary addition, or subtraction, operation is a value that cannot be contained in seven bits $(-128 \le n \le 127)$.

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SECTION 4 PARALLEL INPUT/OUTPUT PORTS & BUS MODES

The devices have 32 I/O lines grouped into four 8-bit ports (PA, PB, PC, and PD). Ports A through C may be used either for input or output individually or in groups of any combination. Port D may be used as all inputs or all outputs.

Multifunction I/O's such as Port A and Port C are protected from normal port I/O instructions when they are programmed to perform a multiplexed function.

Internal pull-up resistors (FET's with an impedance range of $3K \ll R_c \ll 12K$ ohm) are provided on all port pins except Port D. A mask option to delete the internal pull-ups in 8-bit port groups is available.

The direction of the 32 VO lines are controlled by four 8-bit port registers located in page zero. This arrangement provides quick programming access using simple two-byte zero page address instructions. There are no direction registers associated with the VO ports, thus simplifying I/O handling. The I/O addresses are shown in Table 4-1. Appendix E.6 shows the I/O Port Timing.

TABLE 4-1. VO Port Addresses

PORT	ADDRESS	
A	0000	
В	0001	
C	0002	
D	0003	

4.1 INPUTS

Inputs for Ports A, B, and C are enabled by loading logic 1 into all I/O port register bit positions that are to correspond to I/O input lines. A low (<0.8V) input signal will cause a logic 0 to be read when a read instruction is issued to the port register. A high (>2.0V) input will cause a logic 1 to be read. An RES signal forces all I/O port registers to logic 1 thus initially treating all I/O lines as inputs.

Port D may only be all inputs or all outputs. All inputs is selected by setting bit 5 of the Mode Control Register (MCR5) to a "0".

The status of the input lines can be interrogated at any time by reading the VO port addresses. Note that this will return the actual status of the input lines, not the data written into the VO port registers.

Read/Modify/Write instructions can be used to modify the operation of PA, PB, PC, & PD. During the Read cycle of a Read/Modify/Write instruction the Port I/O register is read. For all other read instructions the port input lines are read. Read/Modify/Write instructions are: ASL, DEC, INC, LSR, RMB, ROL, ROR, and SMB.

4.2 OUTPUTS

Outputs for Ports A thru D are controlled by writing the desired I/O line output states into the corresponding I/O port register bit positions. A logic 1 will force a high (>2.4V) output white a logic 0 will force a low (<0.4V) output.

Port D all outputs is selected by setting MCR5 to a "1".

4.3 Port A (PA)

Port A can be programmed via the Mode Control Register (MCR) and the Serial Communications Control Register (SCCR) as a standard parallel 8-bit, bit independent, I/O port or as serial channel I/O lines, counter I/O lines, or an input data strobe for the Port B input latch option. Table 4-2 tabulates the control and usage of Port A.

In addition to their normal I/O functions, PA0 and PA1 can detect positive going edges and PA2 and PA3 can detect negative going edges. A proper transition on these pins will set a corresponding status bit in the IFR and generate an interrupt request if the respective Interrupt Enable Bit is set. The maximum rate at which an edge can be detected is one-half the #2 clock rate. Edge detection timing is shown in Appendix E.5.

TABLE 4-2. Port A Control & Usage

	PAO	VO	PORT 8 LA	CH MODE			
	MCR	. 0	(MCR4	-1)	1	,	
	SIGI	NAL	SIGN	IAL	1		
	NAME	TYPE	NAME	TYPE			
PAD (2) PIN 39	PAO	VO	PORT B	(NPUT (1))			
	PA1-P	A3 1/O	-				
PA1 (2) PIN 38	SIG						
PA2 (3)	NAME	TYPE					
PIN 37 PA3 (3) PIN 36	PA1 PA2 PA3	1/O 1/O					
	PA	11/0		COUNTE	R A VO		
PA4 PIN 38	MCR0 = 0 MCR1 = 0 SCCR7 = 0 RCVR S/R MODE	× - 0 4) (5)	MCR0 = 1 MCR1 = 0 SCCR7 = 0 RCVR S/R MODE		SCCR7 = 0 SCCR6 = 0 MCR1 = 1	1	
	SIG	NAL	SIG	NAL	S	IGNAL	
	NAME	TYPE	NAME	TYPE	NAME	TYPE	
	(PA4)	(10)	CNTA	OUTPUT	CNTA	INPUT (1)	
			SERIAL I/O SHIFT				
SCERTED		SCCR7 = 1 SCCR5 = 1		RCVF	R S/R MODE = 1 (4)		
puput		SIGNAL			SIGNAL		
Service Servic	NAME		TYPE	NAME			
	XMTR CLO	CK	OUTPUT	RCVR CLC	CK	MPOT (I)	
	PA	5 VO	1.	COUNTE	RBVO		
(PAS		2 = 0 ×	MCR3 MCR2			R3 = 1 R2 = X	
PIN 34	SIG	INAL	SIG	NAL	SIGNAL		
	NAME	TYPE	NAME	TYPE	NAME	DYPE	
	PA5	1/0	CNTB	OUTPUT	CNTB	(INPUT (1)	
		ii.					
4 1	PA	6 VO		AL I/O DUTRUT		wing mode combine	
1		R7 = 0		17 - 1)	only pin:	available as an inp	
PAS PIN 33	SIC	SNAL	SIG	NAL		CR6-SCCR5-MCR1 CCR6-SCCR4-MCR1	
	NAME	TYPE	NAME	DYPE	+ SCCR7+S	CCR6-SCCR5	
	PAS	1/0	XMTR	OUTPUT)	+ SCCH7·S	CCR5C-SCCR4.	
	PA	7 VO		AL I/O INPUT			
PAT	SCC	R6 = 0	\$cci	76 = 1			
PIN 32	SK	SNAL	SIG	NAL			
	NAME	TYPE	NAME	TYPE			
	PA7	1/0	BCVB	INPUT (1)	1		

- (1) HARDWARE BUFFER FLOAT
- (2) POSITIVE EDGE DETECT
- (3) NEGATIVE EDGE DETECT
 (4) RCVR S/R MODE = 1 WHEN SCCR6 SCCR5 SCCR4 = 1

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4.4 PORT B (PB)

Port B can be programmed as an 8-bit, bit-independent I/O port, it has a latched input capability which may be enabled or disabled via the Mode Control Register (MCR). Table 4-3 tabulates the control and usage of Port B. An input Data Strobe signal must be provided thru PAO when Port B is programmed to be used with latched input option. Input data latch timing for Port B is shown in Appendix E.S.

TABLE 4-3. Port B Control & Usage

		VO R	HODE	LATCH MODE			
		MCR	4 - 0	MCR4 - 1 (2)			
PIN PIN NAME		810	HAL	SIGNAL			
	2.700	NAME	TYPE (1)	NAME	TYPE		
31	P80	P80	1/0	P80	INPUT		
30	PB1	PB1	1/0	PB1	INPUT		
29	PB2	P82	1/0	PB2	INPUT		
28	PB3	PB3	1/0	PB3	INPUT		
27	P84	PB4	VO	P84	INPUT		
28	PB5	P85	VO	P85	INPUT		
25	P96	P96	VO	PB6	INPUT		
24	P87	PB7	VO	P97	INPUT		

(1) RESISTIVE PULL-UP, ACTIVE SUFFER PULL DOWN
(2) INPUT DATA IS STORED IN PORT B LATCH BY PAG PULSE

4.5 PORT C (PC)

Port C can be programmed as an I/O port, as part of the full address bus, and, in conjunction with Port D, as an abbreviated bus, or as a multiplexed bus. When operating in the Full Address Mode PC6 and PC7 serve as A13 and A14 with PC0-PC5 operating as normal I/O pins. When used in the abbreviated or multiplexed bus modes, PC0-PC7 function as A0-A3, A12, R/W, A13, and EMS, respectively, as shown in Table 4-4. EMS (External Memory Select) is asserted (low) whenever the internal processor accesses memory area between 0100 and 3FFF. (See Memory Mep. Appendix B). The leading edge of EMS may be used to strobe the eight address lines multiplexed on Port D in the Multiplexed Bus Mode. See Appendices E.3 through E.5 for Port C timing.

4.8 PORT D (PD)

Port D can be programmed as an I/O Port, an 6-bit tri-state data bus, or as a multiplexed bus. Mode selection for Port D is made by the Mode Control Register (MCR). The Port D output drivers can be selected as tri-state drivers by setting

bit 5 of the MCR to 1 (one). Table 4-5 shows the necessary settings for the MCR to achieve the various modes for Port D. When Port D is selected to operate in the Abbreviated Mode PD0-PD7 serves as data register bits D0-D7. When Port D is selected to operate in the Multiplexed Mode data bits D0 through D7 are time multiplexed with address bits A4 through A11, respectively. Refer to the Memory Maps (Appendix C) for Abbreviated and Multiplexed memory assignments. See Appendices E.3 through E.5 for Port D timing.

4.7 BUS MODES

A special attribute of Port C and Port D is their capability to be configured via the Mode Control Register (see Section 3.6) Into four different modes.

In the Full Address Mode, the separate address and date bus are used in conjunction with PC6 and PC7, which automatically provide A13 and A14. The remaining ports perform the normal I/O function.

In the I/O Bus Mode all ports serve as I/O. The address and deta bus are still functional but without A13 and A14. Since the internal RAM and registers are in the OOXX location, A15 can be used for chip select and A0-A12 used for selecting 8K of external memory. Thus, the device can be used to emutate the R6500/11 in the Normal Bus Mode.

In the Abbreviated Bus Mode, the address and data lines can be used as in the I/O Bus Mode to emulate the R6500/11. Port C and Port D are automatically transformed into an abbreviated address bus and control signals (Port C) and a bidirectional data bus (Port D). 64 Peripheral addresses can be selected. In general usage, these 64 addresses would be distributed to several externel I/O devices such as R6522 and R6520, etc., each of which may contain more than one unique address.

In the Multiplexed Bus Mode, the operation is similar to the Abbreviated Mode except that a full 16K of external addresses are provided. Port C provides the lower addresses and control signals. Port D multiplexes functions. During the first half of the cycle it contains the remaining necessary 8 address bits for 16K; during the second half of the cycle it contains a bidirectional data bus. The address bits appearing on Port D must be latched into an external holding register. The leading edge of EMS, which indicates that the bus function is active, may be used for this purpose.

Figures 4-1a thru 4-1d show the possible configurations of the four bus modes. Figure 4-2 shows a memory map of the port as a function of the Bus Mode and further shows which addresses are active or inactive on each of the three possible buses.

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TABLE 4-4. Port C Control & Usage

		FULL ADDRESS MODE				NO MODE		ABBREVIATED MODE		PLEXED
			R7 - 8 R6 - 6	MCR MCR	7 - 0 0 - 1		17 - 1 16 - 0		17 - 1 18 - 1	
		SIGNAL		BIGNAL		SIGNAL		SIGNAL		
o PIN		HAME	TYPE	NAME	(1)	NAME	(2)	HANG	(3) \$Ab6	
54	PCO	PCO	VO (1)	PCO	1/0	AO	OUTPUT	AO	OUTPUT	
58	PCI	PC1	10 (1)	PC1	1/0	A1	OUTPUT	A1	OUTPUT	
56	PC2	PC2	10111	PC2	VO.	A2	OUTPUT	RA SA	OUTPUT	
57	PC3	PC3	10(1)	PC3	10	A3	OUTPUT	A3	OUTPUT	
58	PC4	PC4	UO (1)	PC4	1/0	A12	OUTPUT	A12	OUTPUT	
59	PCS	PC5	VO (1)	PCS	HO	n₩	OUTPUT	WIR	OUTPUT	
80	PCB	Ata	DUTPUT (2)	PCB	110	A13	OUTPUT	A13	OUTPUT	
61	PC7	A14	OUTPUT (9)	PCF	NO.	EME	OUTPUT	EAR	OUTPUT	

(1) RESISTIVE PULL-UP, ACTIVE BUFFER PULL-DOWN

(2) ACTIVE BUFFER PULL-UP AND PULL-DOWN

TABLE 4-5. Port D Control & Usage

			I/O MODES				ATED	MULTIPLEXED MODE					
		MCR7 = 0 MCR6 = X MCR5 = 0 2		MCR6 = X MCR6 = X		MCR7 = 1 MCR6 = 0 MCR5 = 1		MCR7 = 1 MCR6 = 1 MCR5 = 1					
		SIG	NAL	SIC	3NAL	SIGN	AL	SIGNAL		SIGNAL			
PIN	PIN		TYPE		TYPE		TYPE	#21	.ow	#2 F	HGH		
	NAME	NAME	(1)	NAME	(2)	NAME	(3)	NAME	TYPE (2)	NAME	TYPE (3)		
62	PD0	PD0	INPUT	PDO	OUTPUT	DATAO	VO	A4	OUTPUT	DATAO	1/0		
63	PD1	PD1	INPUT	PD1	OUTPUT	DATA1	1/0	A5	OUTPUT	DATAI	VO		
84	PD2	PD2	INPUT	P02	OUTPUT	DATA2	1/0	A6	OUTPUT	DATA2	VO		
1	PD3	PD3	INPUT	PD3	OUTPUT	DATAS	1/0	A7	OUTPUT	DATAS	VO		
2	PD4	PD4	INPUT	PD4	OUTPUT	DATA4	1/0	AB	OUTPUT	DATA4	VO		
3	PD5	PD5	INPUT	PD5	OUTPUT	DATAS	1/0	A9	OUTPUT	DATA5	VO		
4	PD6	PD6	INPUT	PD6	OUTPUT	DATA6	1/0	A10	OUTPUT	DATAS	NO.		
5	PD7	PD7	INPUT	PD7	OUTPUT	DATA7	1/0	A11	OUTPUT	DATA7	VO		

(1) TRI-STATE BUFFER IS IN HIGH IMPEDANCE MODE

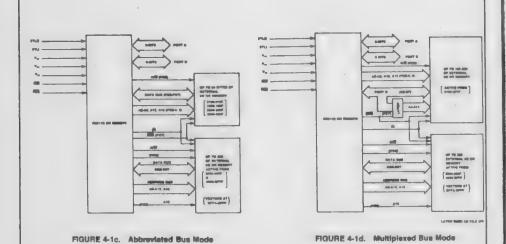
(2) TRI-STATE BUFFER IS IN ACTIVE MODE

(3) TRI-STATE BUFFER IS IN ACTIVE MODE ONLY DURING THE PHASE 2 PORTION OF A WRITE CYCLE

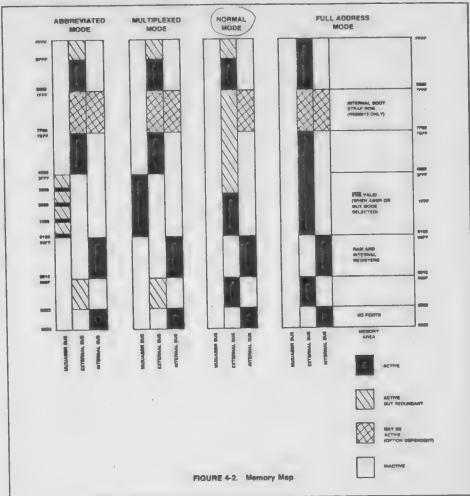
FIGURE 4-1a. Full Address Mode

SUPPLIED ON PARKET

FIGURE 4-1b. Normal Bus Mode



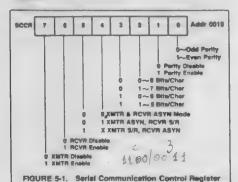
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SECTION 5 SERIAL INPUT/OUTPUT CHANNEL

The device provides a full duplex Serial I/O channel with programmable bit rates and operating modes. The serial I/O functions are controlled by the Serial Communication Control Register (SCCR). The SCCR bit assignment is shown in Figure 5-1. The serial bit rate is determined by Counter A for all modes except the Receiver Shift Register (RCVR S/R) mode for which an external shift clock must be provided. The maximum data rate using the internal clock is 62.5K bits per second (at Ø2 = 1 MHZ). The transmitter (XMTR) and receiver (RCVR) can be independently programmed to operate in different modes and can be independently enabled or disabled.

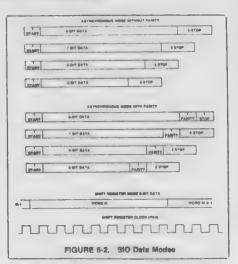


Except for the Receiver Shift Register Mode (RCVR S/R), all XMTR and RCVR bit rates will occur at one sixteenth of the Counter A interval timer rate. Counter A is forced into an interval timer mode whenever the serial VO is enabled in a mode requiring an internal clock.

Whenever Counter A is required as a timing source if must be loaded with the hexadecimal code that selects the data rate for the serial VO Port, Refer to Counter A (paragraph 6.1) for a table of hexadecimal values to represent the desired data rate.

5.1 TRANSMITTER OPERATION (XTMR)

The XTMR operation and the transmitter related control status functions are enabled by bit 7 of the Serial Communications Control Register (SCCR). The transmitter, when in the Asynchronous (ASYN) mode, automatically adds a start bit, one or two stop bits, and, when enabled, a parity. It to the transmitted data. A word of transmitted data (in asynchronous parity mode) can have 5, 6, 7, or 8 bits of data. The nine data modes are shown in Figure 5-2. When parity is disabled, the 5, 6, 7 or 8 bits of data are terminated with two



In the S/R mode, eight data bits are always shifted out. Bits/ character and parity control bits are ignored. The serial data is shifted out via the SO output (PA6) and the shift clock is available at the CA (PA4) pin. When the transmitter underruns in the S/R mode the SO output and shift clock are held in a high state.

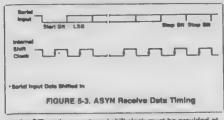
The XMTR Interrupt Flag bit (IFR7) is controlled by Serial Communication Status Register bits SCSR5, SCSR6 and SCSR7

IFR7 = SCSR6 (SCSR5 + SCSR7)

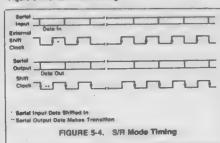
5.2 RECEIVER OPERATION (RCVR)

The receiver and its selected control and status functions are enabled when SCCR-6 is set to a "1," In the ASYN mode, data format must have a start bit, the appropriate number of data bits, a parity bit (if enabled), and one stop bit. Refer to paragraph 5 t for a diagram of bit allocations. The receiver bit period is divided into 8 sub-intervals for internal synchronization. The receiver bit stream is synchronized by the start bit and a strobe signal is generated at the approximate center of each incoming bit. Refer to Figure 5-3 for ASYN Receive Data Timing. The character assembly process does not start If the start bit signal is less than one-half the bit time after a low level is detected on the Receive Data Input. Framing error, over-run, and parity error conditions or a RCVR Data Register Full will set the appropriate status bits. Any of the shave conditions will cause an Interrupt Request if the Receiver Interrupt Enable bit is set to logic 1.

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In the S/R mode, an external shift clock must be provided at CA (PA4) pin along with 8 bits of serial data (LSB first) at the SI input (PA7). The maximum data rate using an external shift clock is one-eighth the internal clock rate. Refer to Figure 5-4 for S/R Mode Timing.



A RCVR interrupt (IFR6) is generated whenever arry of SCSR0-3 are true.

5.3 SERIAL COMMUNICATION STATUS REGISTER (SCSR)

The Serial Communication Status Register (SCSR) holds information on various communication emor conditions, status of the transmitter and receiver data registers, a transmitter end-of-transmission condition, and a receiver idle line condition (Wake-Up Feature). The SCSR bit assignment is shown in Figure 5-5. Bit assignments and functions of the SCSR are as follows:

SCSR 0: Receiver Data Register Full — Set to a logic 1 when a character is transferred from the Receiver Shift Register to the Receiver Data Register. This bit is cleared by reading the Receiver Data Register, or by FiF3 and is disabled if SCCR 6 = 0. The SCRR 0 bit will not be set to a logic 1 if the received data contains an error condition; instead, a corresponding error bit will be set to a logic 1.

SCSR 1: Over-Run Error — Set to a logic 1 when a new character is transferred from the Receiver Shift Register with the last character still in the Receiver Data Register. This bit is cleared by reading the Receiver Data Register or by RES.

SCSR 2: Parity Error—Set to logic 1 when the RCVR is in the ASYN Mode, Parity Enable bit is set, and the

received data has a parity error. This bit is cleared by reading the Receiver Data Register or by RES.

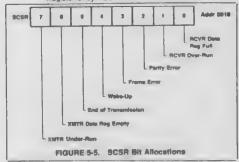
SCSR 3: Framing Error — Set to a logic 1 when the received data contains a zero bit after the last data or parify bit in the stop bit slot. Cleared by reading the Receiver Data Register or by RES (ASYN Mode only).

SCSR 4: Wake-Up — Set to a logic 1 by writing a "1" in bit 4 of address: 0016. The Wake-Up bit is cleared by RES or when the receiver detects a string of ten consecutive 1's. When the Wake-Up bit is set SCSR0 through SCSR3 are inhibited.

SCSR 5: End of Transmission—Set to a logic 1 by writing a "1" in bit position 5 of address 0016. The End of Transmission bit is cleared by RES or upon writing a new data word into the Transmitter Data Register When the End-of-Transmission bit is true the Transmitter Register Empty bit is disabled until a Transmitter Under-Run occurs.

SCSR 6: Transmitter Data Register Empty-Set m a logic 1 when the contents of the Transmitter Data Register are transferred to the Transmitter Shift Register. Cleared upon writing new data into the Transmit Data Register. This bit is initialized to a logic 1 by RES.

SCSR 7: Transmitter Under-Run — Set to a logic 1 when the last data bit is transmitted if the transmitter is in a S/R Mode or when the last stop bit is transmitted if the XMTR is in the ASYN Mode while the Transmitter Data Register Empty Bit is set. Cleared by a transfer of new data into the Transmitter Shift Register or by RES.



5.4 WAKE-UP FEATURE

In a multi-distributed microprocessor or microcomputer applications, a destination address is usually included at the beginning of the message. The Wake-Up Feature allows non-selected CPU's to ignore the remainder of the message until the beginning of the next message by setting the Wake-Up bit as long as the Wake-Up flag is true, the Receiver Data Register Full Flag remains false. The Wake-Up bit is sufformatically cleared when the receiver detects a string of 11 consecutive 1's which indicates an idle transmit line. When the next byte is received, the Receiver Data Register Full Flag signals the CPU to wake-up and read the received data.

SECTION 6 COUNTER/TIMERS

The device contains two 16-bit counters (Counter A and Counter B) and three 16-bit latches associated with the counters. Counter A has one 16-bit latch and Counter B has two 16-bit latches. Each counter can be independently programmed to operate in one of four modes:

Counter A

e Pulse width

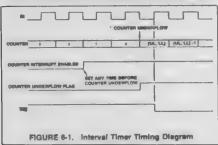
- measurement Pulse Generation
- Interval Timer
- e Event Counter
- Counter B Retriggerable Interval Counter
- Asymmetrical Pulse Generation
- e Interval Timer Event Counter
- Operating modes of Counter A and Counter B are controlled by the Mode Control Register. All counting begins at the initialization value and decrements. When modes are selected requiring a counter input/output line, PA4 is automatically selected for Counter A and PA5 is automatically selected for Counter B (see Table 4.2).

6.1 COUNTER A

Counter A consists of a 16-bit counter and a 16-bit latch organized as follows: Lower Counter A (LCA), Upper Counter A (UCA), Lower Latch A (LLA), and Upper Latch A (ULA). The counter contains the count of either \$2 clock pulses or external events, depending on the counter mode selected. The contents of Counter A may be read any time by executing a read at location 0019 for the Upper Counter A and III location 001A or location 0018 for the Lower Counter A. A read at location 0018 also clears the Counter A Underflow Flag (IFR4).

The 16-bit latch contains the counter initialization value and can be loaded at any time by executing a write to the Upper Latch A at location 0019 and the Lower Latch A at location 0018. In either case, the contents of the accumulator are copied into the applicable latch register.

Counter A can be started at any time by writing to address: 001A. The contents of the accumulator will be copied into the



Upper Latch A before the contents of the 16-bit latch are transferred to Counter A. Counter A is set to the latch value whenever Counter A underflows. When Counter A decrements from 0000 the next counter value will be the latch value-not FFFF-and the Counter A Underflow Flag (IFR 4) will be set to "1". This bit may be cleared by reading the Lower Counter A at location 0018, by writing to address location 001A, or by RES.

Counter A operates in any of four modes. These modes are selected by the Counter A Mode Control bits in the Control

MCR1 (bit 1)	MCR0 (bit 0)	Mode
0	0	Interval Timer
0	1 1	Pulse Generation
1	0	Event Counter
1	1 1	Pulse Width Measurement

The Interval Timer, Pulse Generation, and Pulse Width Measurement Modes are \$2 clock counter modes. The Event Counter Mode counts the occurrences of an external event on the CNTR line.

The Counter is set to the Interval Timer Mode (00) when a RES signal is generated.

6.1.1 Interval Timer

3-194

In the Interval Timer mode the Counter is initialized to the Latch value by either of two conditions:

- 1. When the Counter is decremented from 0000, the next Counter value is the Latch value (not FFFF).
- 2. When a write operation is performed to the Load Upper Latch and Transfer Latch to Counter address 001A, the Counter is loaded with the Latch value. Note that the contents of the Accumulator are loaded into the Upper Latch before the Latch value is transferred to the Counter.

The Counter value is decremented by one count at the #2 clock rate. The 16-bit Counter can hold from 1 to 65535 counts. The Counter Timer capacity is therefore 1µs to 85,535 ms at the 1 MHz Ø2 clock rate or 0.5 µs to 32.767 ms at the 2 MHz #2 clock rate. Time intervals greater than the maximum Counter value can be easily measured by counting IRQ interrupt requests in the counter IRQ interrupt routine.

When Counter A decrements from 0000, the Counter A Underflow (IFR4) is set to logic 1. If the Counter A Interrupt Enable Bit (IER4) is also set, an IRQ interrupt request will be generated. The Counter A Underflow bit in the Interrupt Flag Register can be examined in the IRQ interrupt routine to determine that the IRQ was generated by the Counter A Underflow.

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While the timer is operating in the Interval Timer Mode, PA4 operates as a PA I/O bit.

A timing diagram of the Interval Timer Mode is shown in

8.1.2 Pulse Generation Mode

In the Pulse Generation mode, the CA line operates as a Counter Output. The line toggles from low to high or from high to low whenever a Counter A Underflow occurs or a write is performed to address 001A.

The normal output waveform is a symmetrical square-wave. The CA output is initialized high when entering the mode and transitions low when writing to 001A.

Asymmetric waveforms can be generated if the value of the latch is changed after each counter underflow.

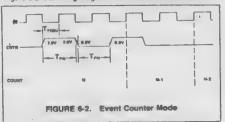
A one-shot waveform can be generated by changing from Pulse Generation to Interval Timer mode after only one occurrence of the output toggle condition.

6.1.3 Event Counter Mode

In this mode the CA is used as an Event Input line, and the Counter will decrement with each rising edge detected on this line. The maximum rate at which this edge can be detected is one-half the \$2 clock rate.

The Counter can count up to 65,535 occurrences before underflowing. As in the other modes, the Counter A Underflow bit (IER4) is set to logic 1 if the underflow occurs.

Figure 6.2 is a timing diagram of the Event Counter Mode.

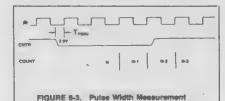


6.1.4 Pulse Width Measurement Mode

This mode allows the accurate measurement of a low pulse duration on the CA line. The Counter decrements by one count at the \$2 clock rate as long as the CA line is held in the low state. The Counter is stopped when CA iii in the high State

The Counter A underflow flag will be set only when the count In the timer reaches zero. Upon reaching zero the timer will be loaded with the latch value and continue counting down as long as the CA pin is held low. After the counter is stopped by a high level on CA, the count will hold as long as CA remains high. Any further low levels on CA will again cause the counter to count down from its present value. The state of the CA line can be determined by testing the state of PA4

A timing diagram for the Pulse Width Messurement Mode is shown in Figure 63.



6.1.5 Serial I/O Data Rate Generation

Counter A also provides clock timing for the Serial VO which establishes the data rate for the Serial VO port. When the Serial I/O is enabled, Counter A is forced to operate at the Internal clock rate. Counter A is not required for the RCVR S/R mode. The Counter I/O (PA4) may also be required to support the Serial VO (see Table 4-2).

Table 6-1 identifies the values to be loaded in Counter A for selecting standard data rates with a \$2 clock rate of 1 MHz and 2 MHz. Although Table 6-1 Identifies only the more common data rates, any data rate from 1 to 62 5K bps can be selected by using the formula:

- decimal value to be loaded into Counter A using its hexadecimal equivalent.

= the clock frequency (1 MHz or 2 MHz)

bps - the desired data rate.

HOTE

In Table 6-1 you will notice that the standard data rate and the actual data rate may be slightly different. Transmitter and receiver errors of 1.5% or less are acceptable. A revised clock rate is included in Table 6-1 for those baud rates which fall outside this limit.

STANDARD SAUD RATE	HEXADI		03 ACTE BAL RATE	O	CLOCK NEE TO C STANI BAUD	DED GET DARD
	1 MHz	2 MHz	1 MHz	2 MHz	1 MHz	2 MHz
50	04E1	09C3	50 00	50 00	1 0000	2 0000
75	0340	0682	75.03	74 99	1 0000	2 0000
110	0237	046F	110 04	110 04	1 0000	2 0000
150	01A0	0340	149 88	150 08	1 0000	2.0000
300	00CF	01A0	300 48	299.76	1 0000	2 0000
600	0067	00CF	600 96	600 96	1 0000	2.0000
1200	0033	0067	1201.92	1201 92	1.0000	2.0000
2400	0019	0033	2403.85	2403.85	1.0000	2 0000
3600	0010	0021	3676 47	3676.47	0 9792	1.9584
4800	000C	0019	4807 69	4807 69	1 0000	2.0000
7200	0000	0010	6944.44	7352 94	1 0366	1 9584
9600	0008	D00C	8928 57	9615.38	1.0752	2 0000

6.2 COUNTER B

Counter III consists of a 18-bit counter and two 16-bit latches organized as follows: Lower Counter III (LCB), Upper Counter B (UCB), Lower Latch III (LLB), Upper Latch B (ULB), Lower Latch C (LLC), and Upper Latch C (ULC), Latch C is used only in the asymmetrical pulse generation mode. The counter contains the count of either \$2. clock pulses or external events depending on the counter mode selected. The contents of Counter III may be read any time by executing a Read at location 0010 for the Upper Counter B and at location 0010 or 0010 for the Lower Counter III and a location 0010 also clears the Counter III Understow Flag.

Latch B contains the **counter** initialization value and can be loaded at any time by executing a Write to the Upper Latch B at location 0010 and the Lower Latch B at location 001C. In each case, the contents of the accumulator are copied into the applicable latch register.

Counter B can be initialized at any time by writing to address: 001E. The contents of the accumulator iii copied into the Upper Latch III before the value in the 16-bit Latch III is transferred to Counter B. Counter B will also be set to the latch value and the Counter III Underflow Flag bit (IFRS) will be set to a "1" whenever Counter B underflows by decrementing from 0000.

IFR 5 may be alread by reading the Lower Counter III at location 001C, by writing to address femalion 001E, or by RES.

Counter B operates in the same manner as Counter A in the Interval Timer and Event Counter modes. The Pulse Wridth Measurement Mode is replaced by the Retriggerable Interval Timer mode and the Pulse Generation mode is replaced by the Asymmetrical Pulse Generation Mode. Mode Control Register bits MCR2 and MCR3 select the four Counter B modes in a similar manner and coding as MCR0 and MCR1 select the modes of Counter A.

6.2.1 Retriggerable Interval Timer Mode

When operating in the Retriggerable Interval Timer mode, Counter B is initialized to the latch value by writing to address 001E, by a Counter B underflow, or whenever a positive edge occurs on the CB pin (PA5). The Counter B interrupt flag will be set if the counter underflows before a positive edge occurs on the CB line. Figure 8-4 illustrates the operation.

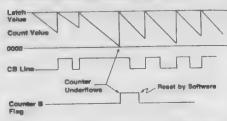


FIGURE 6-4. Counter B. Retriggerable Interval Timer Mode

6.2.2 Asymmetrical Pulse Generation Mode

Counter B has a special Asymmetrical Pulse Generation Mode whereby a pulse train with programmable pulse width and period can be generated without the processor intervention once the latch values are initialized.

In this mode, the 16-bit Latch B is initialized with a value which corresponds to the duration between pulses (referred if as D in the following descriptions). The 16-bit Letch C is initialized with a value corresponding to the desired pulse width (referred to as P in the following descriptions). The initialization sequence for Letch B and C and the starting of a counting sequence are as follows:

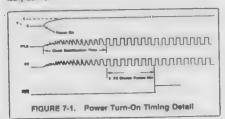
- The lower 8 bits of P are loaded into LLB by writing to address 001C; the upper 8 bits of P are loaded into ULB and the full 18 bits are transferred to Latch C by writing to address location 001D. At this point both Latch III and Latch C contain the value of P.
- The lower 8 bits of D are loaded into LLB by writing to address 001C; the upper 8 bits of D are loaded into ULB by writing to address location 001E. Writing to address location 001E also causes the contents of the 16-bit Latch B to be downloaded into the Counter B and the CB output to go low as shown in Figure 6-5.
- 3. When Counter B underflow occurs the contents of the Latch C are loaded into the Counter III and the CB output toggles to a high level, staying high until another underflow occurs. Latch III is then down-loaded and the CB output toggles to a low level repeating the whole process.

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SECTION 7 POWER ON/INITIALIZATION CONSIDERATIONS

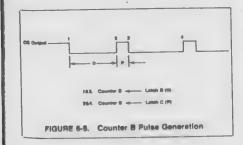
7.1 POWER ON TIMING

After application of V_{cc} and V_{an} power to the device, RES must be held low for at least eight $\beta 2$ clock cycles after V_{cc} reaches operating range and the internal oscillator has stabilized. This stabilization time is dependent upon the input V_{cc} voltage and performance of the internal oscillator. The clock can be monitored at $\beta 2$ (pin 3). Figure 7-1 illustrates the power turn-on waveforms. Clock stabilization time is typically 20 ms.



7.2 POWER-ON RESET

When RES goes from low to high, the device sets the Interrupt Mask Bit—bit 2 of the Processor Status Register—and initiates a reset vector fetch at address FFFC and FFFO (or optionally 7FFE and 7FFF) to begin user program execution. All of the I/O ports (PA, PB, PC, PD) will be forced to the high (logic 1) state. All bits of the Control Register will be cleared to logic 0 causing the interval Timers counter mode (mode 00) to be selected and all interrupt enabled bits to be reset.



7.3 RESET (RES) CONDITIONING

When RES is driven from low to high the device is put in a reset state causing the registers and I/O ports to be configured as shown in Table 7-1.

TABLE 7-1. RES Initialization of I/O Ports and Registers

BIT NO.	7	8	5	4	3	2	1	0
REGISTERS								
Processor Status	-	_	_		~~	-1	_	_
Mode Control (MCR)	0	0	0	0	0	0	0	0
Int. Enable (IER)	0	0	0	0	0	0	0	0
Int. Fleg (IFR)	0	0	0	0	0	0	0	0
Ser. Com Control (SCCR)	0	0	0	0	0	0	0	0
Ser. Com. Status (SCSR)	0	-1	0	0	0	0	0	0
PORTS								
PA Latch	9	- 1	- 1	- 1	-1	- 1	- 1	- 1
PB Latch	1	- 1	9	9	- 1	- 1	- 1	- 1
PC Latch	-1	- 1	- 1	- 1	-1	1	- 1	- 1
PD Latch	1	9	- 1	-1	1	9	-1	- 1

All RAM and other CPU registers will initialize in a random, non-repeatable data pattern.

7.4 INITIALIZATION

Any initialization process for the device should include a RES, as indicated in the preceding paragraphs. After stabilization of the internal clock (if a power on situation) an initialization subroutine should be executed to perform (as a minimum) the following functions:

- 1. The Stack Pointer should be set
- 2. Clear or Set Decimal Mode
- 3. Set or Clear Carry Flag
- 4. Set up Mode Controls as required
- 5. Clear Interrupts

A typical initialization subroutine could be as follows:

LDX	Load stack pointer starting address into
	X Register
TXS	Transfer X Register value to Stack Pointer
CLD	Clear Decimal Mode
SEC	Set Carry Flag
	Set-up Mode Control and
	special function registers
	and clear FIAM as required
CLI	Clear Interrupts

APPENDIX A ENHANCED R6502 INSTRUCTION SET

This appendix contains a summary of the Enhanced R6502 instruction set. For detailed information, consult the R6502 Microcomputer System Programming Manual, Document 29890-N30. The four instructions notated with a * are artised instructions to enhance the standard 6502 instruction set.

A.1 INSTRUCTION SET IN ALPHABETIC SEQUENCE

INEMONIC	INSTRUCTION	MNEMONIC	INSTRUCTION
ADC	Add Memory to Accumulator with Carry	LDA	Load Accumulator with Memory
AND	"AND" Memory with Accumulator	LDX	Load Index X with Memory
ASL	Shift Left One Bit (Memory or Accumulator)	LDY	Load Index Y with Memory
		LSR	Shift One Bit Right (Memory or
-88A	Branch on Bit Reset Relative		Accumulator)
·BBS	Branch on Bit Set Relative		
BCC	Branch on Carry Clear	NOP	No Operation
BCS	Branch on Carry Set		· ·
BEQ	Branch on Result Zero	ORA	"OR" Memory with Accumulator
BIT	Test Bits in Memory with Accumulator		
BMI	Branch on Result Minus	PHA	Push Accumulator on Stack
BNE	Branch on Result not Zero	PHP	Push Processor Status on Stack
BPL	Branch on Result Plus	PLA	Pull Accumulator from Stack
BRK	Force Break	PLP	Pull Processor Status from Stack
BVC	Branch on Overflow Clear		
BVS	Branch on Overflow Set	*RMB	Reset Memory Bit
		ROL	Rotate One Bit Left (Memory or
CLC	Clear Carry Flag		Accumulator)
CLD	Clear Decimal Mode	ROR	Rotate One Bit Right (Memory or
CLI	- Clear Interrupt Disable Bit		Accumulator)
CLV	Clear Overflow Flag	PITI	Return from Interrupt
CMP	Compare Memory and Accumulator	ATS	Return from Subroutine
CPX	Compare Memory and Index X		
CPY	Compare Memory and Index Y	SBC	Subtract Memory from Accumulator w
			Borrow .
DEC	Decrement Memory by One	SEC	Set Carry Fing
DEX	Decrement Index X by One	SED	Set Decimal Mode
DEY	Decrement Index Y by One	SE	Set Interrupt Disable Status
		*SMB	Set Memory Bit
EOR	"Exclusive-Or" Memory with	STA	Store Accumulator in Memory
	Accumulator	STX	Store Index X in Memory
		STY	Store Index Y in Memory
INC	Increment Memory by One		
INX	Increment Index X by One	TAX	Transfer Accumulator to Index X
INY	Increment Index Y by One	TAY	Transfer Accumulator to Index Y
1141	The state of the s	TSX	Transfer Stack Pointer to Index X
JMP	Jump to New Location	TXA	Transfer Index X to Accumulator
JSR	Jump to New Location Saving Return	TXS	Transfer Index X to Stack Register
2011	Address	TYA	Transfer Index Y to Accumulator

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																	1	9	RES	SIN	ADDRESSING MODES	QQ	83																		E .	PNOCESSOR STATUS CODES	S SOM S	S T.	27.0	-
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		80	6	8	8	b	8	0	8	4	•	8		8	e	8	耳	9	8	3	å	2	ò	0 4 40	٠	ð	3	00		0	000	1	•	-	~	1	4	-	-		=	2 0 0 0	0	-		-
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OSM	0	1	510	3	4	5	0	7	8	9	A		С	D	E	F
	BRK	ORA				ARO	ASL	PMB0	PHP	ORA	ASL			ARO	ASL	8880
. 10	Implied	(IND, X)				Tr.	ZP	P	Implied	THAN	Accum			ABS	A89	ZP
1	1 7	2/6				2)3	3 5	23/	1) 3v	3 2	1)24			3 40	-	(3) 5
7.9	BPL	OFA				ORA !	ASL	RMB1)	CLC	ORA				DRA	ASL	BBRI
1	Relative	(RND), Y				ZP, X 2 4	ZP. X 2 8	2P 2 5	Implied 1 2	A88, Y				ABS, X	ABS, X	3 5"
	JSB	AND														
V #	Absolute	(IND. XI)			BIT ZP	AND ZP	FICIL ZP	EMB3	PLP	OMA	Accum		BIT	AND ABS	ROL ABS	BBR2 ZP
	3 8	2 0 1			2 3	2 3	2 5	2. 5	1 4	2 2	1 2		3 4	3 4	3 6	3 5"
,	BMI	AND				AND	ROL	PMB3	SEC	AND				AND	ROL	BBB3
V3	Relative	(ND. Y)				ZP. X	ZP, X	ZP	Implied	ABS, Y				X ,28A	ABS, X	ZP
_	5 5	2 5				2 4	2 6	2 5	1 2	3 41,				3 4"	3 7	3 5"
	PITI	EOR				EOA	LSA	RMB4	PHA	EOA	LSR		JMP	EOR	LSA	88R4
V4	Implied	(INO, X)				ZP	ZP	ZP	Implied	IMM	Accum		ABS	A89	ABS	ZP
V	1 6	2 6				2 3	2 5	2 5	1 3	2 2	1.5		3 3	3 4	3 6	3 5
1	BVC	EOR				EOR	LSR	PMB5	CLI	EOR				EOR	LSR	99 P6
V.	Relative 2 2"	(IND), Y .				ZP, X	ZP, X	2 P	Implied 1 2	ABS, Y				ABS, X	ABS, X :	3 5
								-		_			-			-
1/8	RTS Implied	ADC (IND, X)				ADC ZP	ROR	PM86	PLA	ADC	ROR		JMP	ADC	ROR	38 7 6
V.	1 6	2 6				2 3	2 8	2 P	Implied	IMM 2 2	Accum		Indirect	A88	A88	3 5"
	BVS	ADC		_	-			-					-			_
7	Relative	(IND. Y)				ADC ZP, X	ROA ZP. X	PMB7	SEI	ADC ABS. Y				ADC ABS, X	ABS. X	BBA7
	5 5	2 5				2 4	2 6	2 5	1 2	3 4°				3 4"	3 7	3 5
PERM		STA			STY	STA	STX	SMBO	DEY	1.37	TXA		STY	STA	STX	8930
		(IND, X)			ZP	ZP	ZP	ZP	Implied	1	Implied		ABS	ABS	AB9	ZP
		2 6			2 3	2 3	2 3	2 8	1 2	-	1 2		3 4	3 4	3 4	3 5"
	BCC	STA			STY	STA	STX	SMB1	TYA	STA	TXS			STA		9851
7 8	Relative	(IND, Y)			ZP, X	ZP, X	ZP, Y	ZP	Implied	ABS, Y	Implied			ABS, X		ZP
	2 2	2 8			2 4	2 4	2 4	2 5	1 2	3 5	1 2			3 5		3 5"
1/.	LDY	LDA	LOX		LDY	LDA	LDX	SMB2	TAY	LDA	TAX		LDY	LDA	LDX	8852
VA	BMM 2 2	(IND, X)	1MM2 2 2		2P	ZP 2 3	ZP 2 3	ZP	Implied	19/19/4	Implied		ABS	ABS	ABS	3 5°
			4 4		-	-		2 5	1 2	2 2	1 2		3 4	3 4	3 4	-
1/0	BC9 Relative	LDA (IND), Y			LDY ZP, X	LDA ZP, X	LDX ZP, Y	SM83	CLV	LDA ABS, Y	T9X Implied		ABS, X	ABS, X	LDX AB9. Y	8853 ZP
0.0	5 5	2 5			2 4	2 4	2 4	2 5	1 2	3 4"	1 2		3 4°	3 4°	3 4"	3 5
	CPY	CMP			CPY	CMP	DEC	SMB4	INY	CMP	DEX		CPY	CMP	DEC	8834
Vc	IMM	(IND. 10)			ZP	ZP	ZP	Zp SMB4	Implied	IMM	Implied		ARS	ABS	ABS	ZP
V	2 2	2 8			2 3	2 3	2 5	2 5	1 2	2 2	1 2		3 4	3 4	3 6	3 5
	BNE	CMP				CMP	DEC	SMBS	CLD	CMP			1	CMP	DEC	8686
10	Relative	(IND), Y				ZP, X	ZP, X	2P	Implied	ABB, Y				ABS, X	ABS, X	ZP
V	5 5	2 5.				2 4	2 6	2 5	1 2	3 4"				3 4"	3 7	3 5"
	CPX	BBC			CPX	SBC	INC	SMB6	INX	SBC	NOP		CPX	SBC	INC	8896
VE.	IMM	(IND, X)			ZP	ZP	ZP	ZP	Implied	IMM	Implied .		ABB	ABS	A88	ZP
	2 2	2 0			2 3	2 3	2 5	2 5	1 2	2 2	1 2		3 4	3 4	3 8	3 5
-	BEQ	SBC				38C	INC	SMB7	SED	SBC				SBC	INC	8837
100	I Malativa	(IND), Y				ZP. X	ZP, X	ZP	Implied	ABS. Y			1	A85. X	ABS, X	ZP

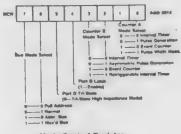
"Add 1 to N If page boundary is crossed.
""Add 1 to N If branch occurs to same page;
add 2 to N If branch occurs to different page.

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APPENDIX B KEY REGISTER SUMMARY



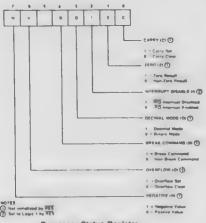
CPU Registers



Mode Control Register

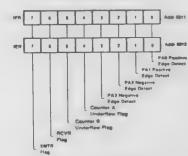


Serial Communications Control Register

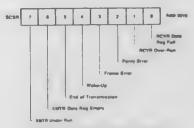


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Processor Status Register



Interrupt Enable and Flag Registers



Serial Communications Status Register

BAK

Implied

-OP Code

-Addressing Mode

--- Instruction Bytes; Machine Cycles

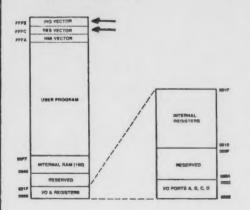
APPENDIX C ADDRESS ASSIGNMENTS/MEMORY MAPS/PIN FUNCTIONS

C.1 I/O AND INTERNAL REGISTER ADDRESSES

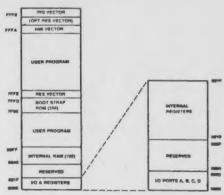
ADDRESS (HEX)	READ	WRITE
001F		
16	Lower Counter B	Upper Latch B, Cntr B-Latch B, CLR Flag
10	Upper Counter B	Upper Latch B, Latch C-Latch B
16	Lower Counter B, CLR Flag	Lower Latch B.
18		
1A	Lower Counter A	Upper Latch A, Cntr A←Latch A, CLR Flag
19	Upper Counter A	Upper Latch A
18	Lower Counter A, CLR Flag	Lower Latch A
17	Serial Receiver Data Register	Serial Transmitter Data Register
16	Serial Comm. Status Register	Serial Comm. Status Reg. Bits 4 & 5 only
15	Serial Comm. Control Register	Serial Comm. Control Register
14	Mode Control Register	Mode Control Register
13		NEW 200
12	Interrupt Enable Register	Interrupt Enable Register
11	Interrupt Flag Register	
0010	Read FF	Clear Int Flag (Bits 0-3 only, Write 0's only)
OF		
0E		
00		
OC		
OB	T	RESERVED
0A		TEGETTEG
09	These addresses are reserve	ed and are used by the CPU during Read and Write
08	operation over the external D	
07	†	
08		
05		
04		
03	Port D	Port D
		Port C
02	Port C	
	Port B	Port 8

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C.2 FULL ADDRESS MODE MEMORY MAP R6511Q OR R6500/13



C.3 FULL ADDRESS MODE MEMORY MAP R6500/13 ONLY



C.4 MULTIPLE FUNCTION PIN ASSIGNMENTS—PORT C AND PORT D

PIN NUMBER	FULL ADDRESS MODE	I/O PORT FUNCTION	ABBREVIATED PORT FUNCTION	MULTIPLEXED PORT
54	PC0	PC0	AO	AO
55	PC1	PC1	A1	A1 -
56	PC2	PC2	A2	A2
57	PC3	PC3	A3	A3
58	PC4	PC4	A12	A12
59	PC5	PC5	R/W	R/W
60	A13	PC6	A13	A13
61	A14	PC7	EMS	EMS
62	PD0	PD0	DO	A4/D0
63	PD1	PD1	01	A5/D1
64	PD2	PD2	D2	A6/D2
1	PD3	P03	D3	A7/D3
2	P04	PD4	D4	A8/D4
3	PD5	PD5	D5	A9/D5
4	PD6	PD6	D6	A10/D6
5	PD7	PD7	D7	A11/D7

APPENDIX D **ELECTRICAL SPECIFICATIONS**

Maximum Ratings

RATING	SYMBOL	VALUE	UNIT
Supply Voltage	Vcc & Van	-0.3 to +7.0	Vdc
Input Voltage	Vin	-0.3 to +7.0	Vde
Operating Temperature Range, Commercial, Industrial		0 to +70 -40 to +85	C
Storage Temperature Range	Torq	-55 to +150	°C

NOTE: This device contains circulity to protect the inputs against damage due to high static voltages; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this circuit.

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
Power Dissipation (Outputs High) Commercial @ 0°C Industrial @ ~40°	Po	-	750(1)	- 1100 1200	mW
RAM Standby Voltage (Retention Mode)	V _{no}	3.0		Vcc	Vdc
RAM Standby Current (Retention Mode) Commercial @ 25°C Industrial @ 25°C	Inn	-	4 5.2	_	mAdo
Input High Voltage (Except XTLI)	V _{os}	+2.0	-	Vcc	Vdc
Input High Voltage (XTLI)	Vos	+4.0	-	Vce	Vdc
Input Low Voltage	V _n	-0.3	-	+0.8	Vdc
Input Leakage Current (RES, NMI) V _{in} = 0 to 5.0 Vdc	1,10			±10.0	μAdo
Input Low Current PA, PB, PC, PD (Vs. = 0.4 Vdc)	t _{is}	-	-1.0	-1.6	mAdo
Output High Voltage (Except XTLO) (I _{see} ~ .100 µAdc)	V _{dos}	+2.4	-	Vcc	Vdc
Output Low Voltage (L _{unit} = 1.6 mAdc)	V _{OL}	-	-	+0.4	Vdc
			*		-
Input Capacitance (V _{in} -0, T _a = 25°C, f = 1.0 MHz) XTL, XTLQ All Others	Cta	=	=	50	pF
I/O Port Pull-Up Resistance PA0-PA7, PB0-PB7, PC0-PC7	R	3.0	6.0	11.5	ΚΩ
Output Leakage Current Tri-State t/O's while in High Impedance State	lour	-	_	±10	μAdd
Output Capacitance Tri-State U0's white in High Impedance State V _m = 0V, TA = 25°C, f = 1.0 MHz	Соцт	-	-	10	pF

NOTE: Negative sign indicates outward current flow, positive indicates inward flow. (1) # 25°C

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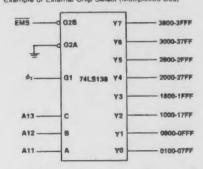
APPENDIX E TIMING REQUIREMENTS AND CHARACTERISTICS

E.1 GENERAL NOTES

- 1. Vcc = 5V ±5%, 0°C < TA = 70°C
- 2. A valid V_{cc} RES sequence is required before proper operation is achieved.
- 3. All timing reference levels are 0.8V and 2.0V, unless otherwise specified.
- 4. All time units are nanoseconde, unless otherwise specified.
- 5. All capacitive loading is 130pf maximum, except as noted

PA, PB	_	50pf maximum
PC (I/O Modes Only)	_	50pf maximum
PC (ABB and Mux Mode)	-	130pf maximum
PC6 PC7 (Full Address Mode)	-	130of maximum

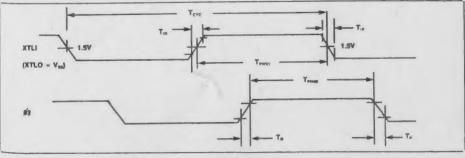
6. Example of External Chip Select (Multiplexed Bus)



Note that both EMS and Phase 2 (6) must be used to correctly enable the chip selects in the multiplexed or abbreviated bus modes.

E.2 CLOCK TIMING

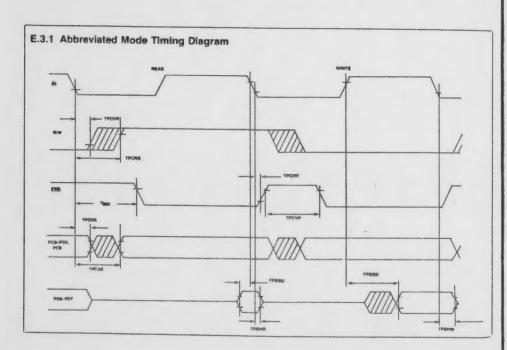
		1 1	Mz	2 N	IHz
SYMBOL	PARAMETER	MIN	MAX	MIN	MAX
Teve	Cycle Time	1000	10 µ8	500	10 με
Tewns	XTLI Input Clock Pulse Width XTLO = VSS	500 ± 25	-	250 ± 10	-
Trees	Output Clock Pulse Width at Minimum Tove	Trees	T _{PWZ1} ± 25	Towns	Trwes
Ta, Tp	Output Clock Rise, Fall Time	-	25	-	15
Tim, Tip	Input Clock Rise, Fall Time	-	10	-	10



E.3 ABBREVIATED MODE TIMING-PC AND PD

(MCR 5 = 1, MCR 6 = 0, MCR 7 = 1)

SYMBOL	PARAMETER	11	MHz	21	WHz
	PANAMETER	MIN	MAX	MIN	MAX
Tecns	(PC5) RW Setup Time	-	225	-	140
TPEAS	(PC0-PC4, PC6) Address Setup Time	-	225	-	140
Tresu	(PD) Data Setup Time	50	-	35	-
Тевия	(PD) Data Read Hold Time	10	-	10	-
Транш	(PD) Data Write Hold Time	30	-	30	_
Teaso	(PD) Data Output Delay	-	175	-	150
Терна	(PC0-PC4, PC6) Address Hold Time	30	-	30	-
Терня	(PC5) R/W Hold Time	30	-	30	-
TPCHY	(PC7) EMS Hold Time	10	_	10	_
Teche	(PC7) EMS Stabilization Time	30	-	30	-
Teeu	EMS Setup Time	-	360	-	210



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E.4 MULTIPLEXED MODE TIMING-PC AND PD

(MCR 5 = 1, MCR 6 = 1, MCR 7 = 1)

		1 1	AHz	21	AHE
SYMBOL	PARAMETER	MIN	MAX	MIN	MAX
Тисля	(PC5) R/W Setup Time '	-	225	-	140
Troas	(PC0-PC4, PC6) Address Setup Time	inna	225	-	140
Трама	(PD) Address Setup Time	-	225	-	140
Треви	(PD) Data Setup Time	50		35	-
Тирин	(PD) Data Read Hold Time	10	-	10	_
Traver	(PD) Data Write Hold Time	30	-	30	-
Tesoo	(PD) Data Output Delay	-	175	-	150
Тисна	(PC0-PC4, PC6) Address Hold Time	30	-	30	-
Трема	(PD) Address Hold Time	10	100	10	80
Tecon	(PC5) R/W Hold Time	30	-	30	-
Тисич	(PC7) EMS Hold Time	10	-	10	-
Tecve	(PC7) Address to EMS Delay Time	30		30	
Tecup	(PC7) EMS Stabilization Time	30	-	30	-
Tesu	EMS Setup Time		350	-	210

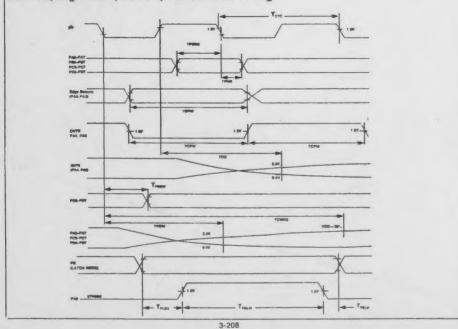
NOTE 1: Values assume PC0-PC4, PC6 and PC7 have the same capacitive load.

E.5 I/O, EDGE DETECT, COUNTERS, AND SERIAL I/O TIMING

SYMBOL	PARAMETER	S MHHz		2 MHz	
		10001	MAX	10000	MAX
	Internal Write to Peopheral Data Valid				
Tene	PA, PB, PC TTL		500	-	500
Town	PA, PB. PC CMOS	-	1000	-	1000
TPOOW	PD	-	175	-	150
	Peripheral Data Setup Time				
Tenn	PA. PB. PC	200	ine.	200	1000
Tennu	PO	50	-	50	(de-
	Peripheral Data Hold Time				
Town	PA. PB. PC	75	_	75	-
Ymen	PO	10	-	10	-
Terw	PA0-PA3 Edge Detect Pulse Width	Teve	-	Teve	-
	Counters A and B				
Torm	PA4, PAS Input Pulse Width	Yese	-	Tere	-
Teette	PA4, PA5 Output Delay	-	900	-	500
	Port 8 Latch Mode				
Tenw	PA0 Strobe Pulse Width	Teve		Teve	-
Tenev	PB Data Setup Time	175	-	150	-
Tegen	P8 Data Hold Time	30	-	30	-
	Serial VO				
Toowitt	PAS XMTR TTL		500	-	500
Towns"	PAS XMTR CMOS	-	1000	-	1000
Torus	PA4 RCVR S/R Clock Width	4 Tere	=	4 Teva	-
Trow III	PA4 XMTR Clock-S/R Mode (TTL)	-	900	-	50
Tomps(1)	PA4 XMTR Clock-3/R Mode (CMOS)	1000	1000	-	1000

NOTE 1: Meximum Load Capacitance: 50p Passive Put-Up Required

E.5.1 I/O, Edge Detect, Counter, and Serial I/O Timing



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E.6 MICROPROCESSOR TIMING (D0-D7, A0-A12, A15, SYNC, R/W)

	PARAMETER	1 MHz		2 MHz	
SYMBOL		MIN	MAX	MIN	MAX
Taws	R/W Setup Time	-	225	-	140
Taps	A0-A12, A15 Setup Time	-	225	-	140
Toeu	D0-D7 Data Setup Time	50	-	35	-
THR)	00-07 Read Hold Time	10	-	10	-
Tun	D0-D7 Write Hold Time	30	-	30	-
Тыов	D0-D7 Write Output Delay		175	-	150
Tavn	SYNC Selup	-	225		175
Тиа	A0-A12, A15 Hold Time	30	-	30	-
THRW	P/W Hold Time	30	-	30	-
Tacc	External Memory Access Time T _{ACC} = T _{CYC} —T _F — T _{AOS} —T _{DSU}	-	Tacc	-	TAC
Tave	SYNC Hold Time	30	1-	30	-

